

DECLARATION OF CHINA RoHS STATUS

PRODUCT	SERIES	EU RoHS COMPLIANT	EU RoHS EXEMPTIONS (S)	CHINA RoHS COMPLIANCE STATUS	CHINA RoHS EFUP	Pb	Hg	Cd	Cr64	PBBs	PBDEs
General Purpose MLCC	GMC	YES	NONE	YES		0	0	0	0	0	0
High Voltage MLCC	CHV	YES	NONE	YES		0	0	0	0	0	0
Cap Arrays	GMY	YES	NONE	YES		0	0	0	0	0	0
High Q Caps	GHQ	YES	NONE	YES		0	0	0	0	0	0
Ultra High Q Caps	GUQ	YES	NONE	YES		0	0	0	0	0	0
Auto Grade Caps	GMG	YES	NONE	YES		0	0	0	0	0	0
AEC-Q200 Qualified	GMT	YES	NONE	YES		0	0	0	0	0	0
General Purpose Tantalum	TC	YES	NONE	YES		0	0	0	0	0	0
Low ESR Tantalum	TC****LSR	YES	NONE	YES		0	0	0	0	0	0
Thick Film Chip Green Res.	RL	YES	NONE	YES		0	0	0	0	0	0
Thick Film Current Sense Res.	RST	YES	NONE	YES		0	0	0	0	0	0
Thin Film Precision Res Array	RN	YES	NONE	YES		0	0	0	0	0	0
Thick Film High Volt Res.	RHV	YES	NONE	YES		0	0	0	0	0	0
Thick Film High Ohmic	RHO	YES	NONE	YES		0	0	0	0	0	0
Thick Film Long Side Term	LCP	YES	NONE	YES		0	0	0	0	0	0
Auto Grade Thin Film	CPR	YES	NONE	YES		0	0	0	0	0	0
Thin Film Cur. Sense	RCS	YES	NONE	YES		0	0	0	0	0	0
Thin Film Anti Corrosive	RNC	YES	NONE	YES		0	0	0	0	0	0
Low Ohm Metal Strip	LOR	YES	NONE	YES		0	0	0	0	0	0
Ultra Low Ohm Metal Strip	RUL	YES	NONE	YES		0	0	0	0	0	0
Metal Alloy Cur. Sense Res	CML	YES	NONE	YES		0	0	0	0	0	0
Melf Resistors	CMR	YES	NONE	YES		0	0	0	0	0	0
Power Resistors	RTR, SPR	YES	NONE	YES		0	0	0	0	0	0

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X: Indicates that this toxic or hazardous substance contained in the homogeneous materials for this part, according to EIP-A, EIP-B, EIP- C is above the limit requirement in SJ/T11363-2006.

REPRESENTATIVE: Kenny Lin
TITLE: Quality Control Manager
DATE: 3/1/2026



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Thin Film Resistor Array	CNP	YES	NONE	YES		0	0	0	0	0	0
Auto Grade Thickfilm Anti Sulfur	CAS	YES	NONE	YES		0	0	0	0	0	0
Auto Grade Thickfilm	CAR	YES	NONE	YES		0	0	0	0	0	0
Metal Strip Cur. Sense.	CRM	YES	NONE	YES		0	0	0	0	0	0
Auto Grade Thickfilm Cur. Sense	CRS	YES	NONE	YES		0	0	0	0	0	0
Thick Film Surge Withstand	CWR	YES	NONE	YES		0	0	0	0	0	0
Thick Film Chip Inductors	TCF	YES	NONE	YES		0	0	0	0	0	0
SMD Power Inductors	CS	YES	NONE	YES		0	0	0	0	0	0
SMD Power Inductors	CCD	YES	NONE	YES		0	0	0	0	0	0
SMD Shielded Power Inductors	CS	YES	NONE	YES		0	0	0	0	0	0
SMD Shielded Ferrite Core	CSDB	YES	NONE	YES		0	0	0	0	0	0
SMD Shielded WW PWR IND.	CBD	YES	NONE	YES		0	0	0	0	0	0
SMD Shielded WW PWR IND. LP	CSDS	YES	NONE	YES		0	0	0	0	0	0
Multilayer Chip Inductors	GLF	YES	NONE	YES		0	0	0	0	0	0
Hlgh Freq. Multilayer Chip Ind.	GHF	YES	NONE	YES		0	0	0	0	0	0
Ceramic Core Wire Wound Ind.	WB	YES	NONE	YES		0	0	0	0	0	0
SMD Open Wound Pwr Ind.	SSL	YES	NONE	YES		0	0	0	0	0	0
Common Mode Choke Ind.	CMH	YES	NONE	YES		0	0	0	0	0	0
Ferrite Beads	FB, FBH, FBU	YES	NONE	YES		0	0	0	0	0	0
SMD Electrolytics	CV	YES	NONE	YES		0	0	0	0	0	0
Polymer Lytics	CCV, CCVZ	YES	NONE	YES		0	0	0	0	0	0
Chip LEDS	CC-	YES	NONE	YES		0	0	0	0	0	0
Molded Chip Wire Wound Ind	NL	YES	NONE	YES		0	0	0	0	0	0

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Thick Film Chip Res	RM	YES	7C1	YES		0	0	0	0	0	0
Thick Film Resistor Array	CN	YES	7C1	YES		0	0	0	0	0	0

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